# ne<mark>x</mark>peria

### Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia



BAT720 Schottky barrier diode Rev. 4 – 14 November 2012

**Product data sheet** 

# 1. Product profile

### 1.1 General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

### **1.2 Features and benefits**

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

### 1.3 Applications

- Ultra high-speed switching
- Line termination

- Voltage clamping
- Reverse polarity protection

### **1.4 Quick reference data**

### Table 1. Quick reference data

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>R</sub>	reverse voltage		-	-	40	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 500 mA	<u>[1]</u> _	-	550	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 35 V	<u>[1]</u> _	-	100	μA

 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu \mbox{s; } \delta \leq 0.02. \end{tabular}$ 

# 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
1	anode		
2	not connected		3
3	cathode		1 2 006aaa436



# 3. Ordering information

Table 3. Orde	ring inform	ation	
Type number	Package		
	Name	Description	Version
BAT720	-	plastic surface-mounted package; 3 leads	SOT23

## 4. Marking

Table 4.	Marking codes		
Type num	ber	Marking code <sup>[1]</sup>	
BAT720		L6*	

[1] \* = placeholder for manufacturing site code.

# 5. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions	Min	Max	Unit
reverse voltage		-	40	V
forward current		-	500	mA
non-repetitive peak forward current	square wave; t <sub>p</sub> < 10 ms	[1] -	2	A
total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2] _	200	mW
junction temperature		-	125	°C
ambient temperature		-55	+125	°C
storage temperature		-65	+150	°C
	reverse voltage forward current non-repetitive peak forward current total power dissipation junction temperature ambient temperature	reverse voltageforward currentnon-repetitive peak forward currentsquare wave; $t_p < 10 ms$ total power dissipation $T_{amb} \le 25 \ ^{\circ}C$ junction temperatureambient temperature	reverse voltage-forward current-non-repetitive peak forward currentsquare wave; $t_p < 10 ms$ total power dissipation $T_{amb} \le 25 \ ^{\circ}C$ junction temperature-ambient temperature-55	reverse voltage-40forward current-500non-repetitive peak forward currentsquare wave; $t_p < 10 ms$ 1-2total power dissipationTamb ≤ 25 °C2200junction temperature-125ambient temperature-55+125

[1]  $T_j = 25 \ ^{\circ}C$  before surge.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

BAT720
Product data sheet

Schottky barrier diode

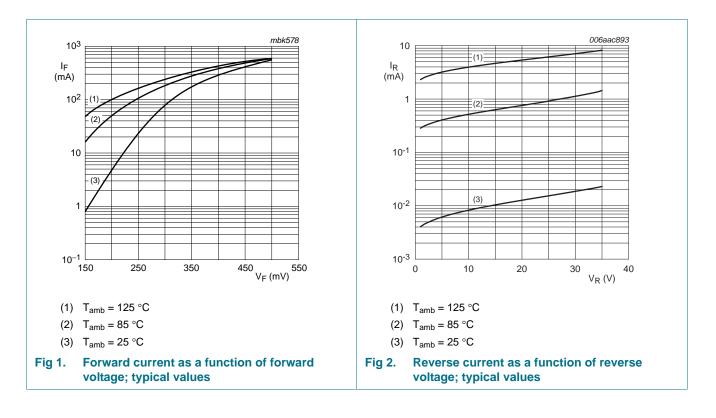
# 7. Characteristics

Table 7.	Characteristics

$T_j = 25 \ ^{\circ}C$ unless otherwise specified.	
--	--

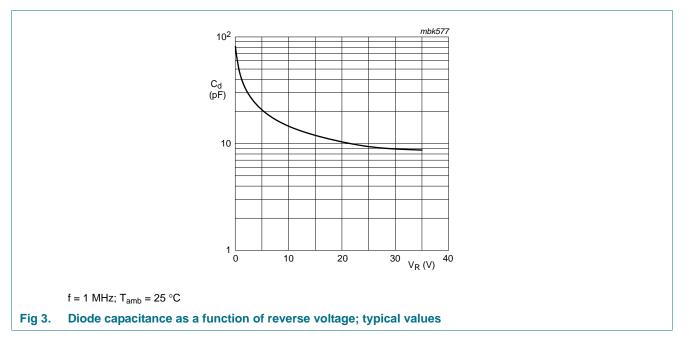
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 500 mA	<u>[1]</u> _	-	550	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 35 V	<u>[1]</u> _	-	100	μΑ
		$V_R = 35 \text{ V}; \text{ T}_j = 100 ^{\circ}\text{C}$	<u>[1]</u> _	-	10	mA
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$	60	-	90	pF

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .



### **NXP Semiconductors**

# BAT720 Schottky barrier diode

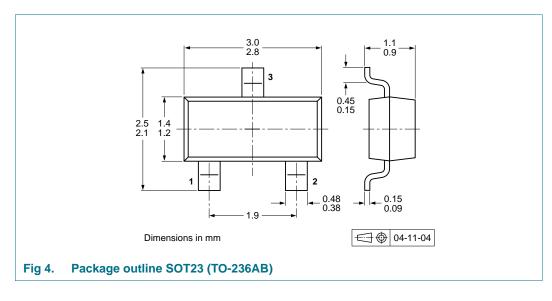


# 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.





# **10. Packing information**

### Table 8. Packing methods

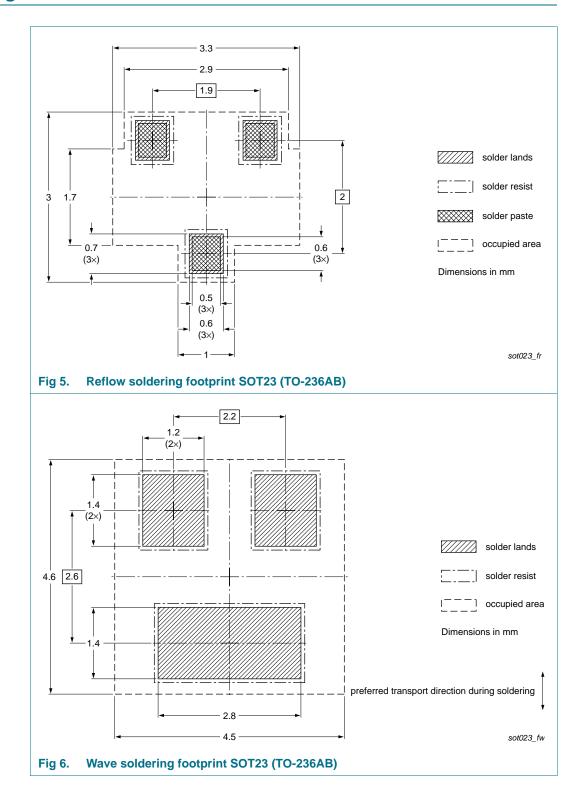
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
BAT720	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

BAT720 Schottky barrier diode

# 11. Soldering



# 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BAT720 v.4	20121114	Product data sheet	-	BAT720 v.3		
Modifications:		of this document has been of NXP Semiconductors.	redesigned to comply w	ith the new identity		
	<ul> <li>Legal texts</li> </ul>	have been adapted to the r	new company name whe	ere appropriate.		
	Section 1: 0	updated				
	• <u>Section 4</u> : updated					
	<ul> <li><u>Table 5</u>: added ambient temperature T<sub>amb</sub> and total power dissipation P<sub>tot</sub></li> </ul>					
	• Figure 2: updated					
	<ul> <li><u>Section 8 "Test information"</u>: added</li> </ul>					
	<ul> <li>Figure 4: replaced by minimized package outline drawing</li> </ul>					
	<ul> <li>Section 10 "Packing information": added</li> </ul>					
	<ul> <li><u>Section 11 "Soldering</u>": added</li> </ul>					
	Section 13	"Legal information": update	d			
BAT720 v.3	20030325	Product data sheet	-	BAT720 v.2		
BAT720 v.2	19990526	Product specification	-	BAT720 v.1		
BAT720 v.1	19980121	Product specification		-		

# 13. Legal information

### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### 13.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

### Suitability for use in automotive applications - This NXP

Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product sole and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

### Schottky barrier diode

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

### 13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

# 14. Contact information

For more information, please visit: <a href="http://www.nxp.com">http://www.nxp.com</a>

For sales office addresses, please send an email to: salesaddresses@nxp.com

# **BAT720**

# **15. Contents**

1	Product profile
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 2
7	Characteristics 3
8	Test information 4
8.1	Quality information 4
9	Package outline 5
10	Packing information 5
11	Soldering 6
12	Revision history 7
13	Legal information 8
13.1	Data sheet status 8
13.2	Definitions 8
13.3	Disclaimers 8
13.4	Trademarks 9
14	Contact information 9
15	Contents 10

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2012.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 14 November 2012 Document identifier: BAT720

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Schottky Diodes & Rectifiers category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

CUS06(TE85L,Q,M) MA4E2039 D1FH3-5063 MBR0530L-TP MBR10100CT-BP MBR30H100MFST1G MMBD301M3T5G PMAD1103-LF PMAD1108-LF RB160M-50TR RB520S-30 RB551V-30 DD350N18K DZ435N40K DZ600N16K BAS16E6433HTMA1 BAS 3010S-02LRH E6327 BAT 54-02LRH E6327 IDL02G65C5XUMA1 NSR05F40QNXT5G JANS1N6640 SB07-03C-TB-H SB1003M3-TL-W SBAT54CWT1G SK32A-LTP SK33A-TP SK34A-TP SK34B-TP SMD1200PL-TP ACDBN160-HF SS3003CH-TL-E STPS30S45CW PDS3100Q-7 GA01SHT18 CRS10I30A(TE85L,QM MA4E2501L-1290 MBR1240MFST1G MBRB30H30CT-1G BAS28E6433HTMA1 BAS 70-02L E6327 HSB123JTR-E JANTX1N5712-1 VS-STPS40L45CW-N3 DD350N12K SB007-03C-TB-E SK110-LTP SK154-TP SK32A-TP SK33B-TP SK35A-TP